**Solderless Breadboard**

**Specifications**
- **Housing Material**: ABS Plastic
- **Spring Clips**: Copper, Ni plated
- **Wire Range**: Solid 29AWG to 20AWG
- **Rated Voltage**: 300V
- **Rated Current**: 3A to 5A
- **4 Terminal Strip**: 2,520 Tie-point
- **7 Distribution Strip**: 700 Tie-point
- **4 Binding posts**
- **Black Metal Plate**: 207mm × 235mm × 1mm
- **Pitch**: 2.54mm
- **Dimensions**: 186mm × 191mm × 8.3mm

**Diagram**

**Part Number Table**

<table>
<thead>
<tr>
<th>Description</th>
<th>Part Number</th>
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<tr>
<td>Solderless Breadboard</td>
<td>MCBB3060</td>
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